

LINEAR TECHNOLOGY MATERIALS DECLARATION

1tc2923ims#trpbf

(Engineering Calculation)

MSOP

(printed on: 2020-07-11 22:09:55)

TOTAL MASS (g) : 0.027339

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002037	1000000	74508.8671875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	381615.59375		
		Iron (Fe)	7439-89-6	0.000257	24000	9400.48144531		
		Phosphorus (P)	7723-14-0	0.000003	300	109.733253479		
		Zinc (Zn)	7440-66-6	0.000007	700	256.044250488		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.010700	1000000	391381.90625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	25971.1152344		
		External Plating Total:				0.000710	1000000	25971.1152344
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3145.6862793		
Internal Plating Total:				0.000086	1000000	3145.6862793		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000700	750000	25604.4238281		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000233	250000	8522.61523438		
Die Attach Total:				0.000933	1000000	34127.0390625		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	60682.4804688		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	387394.9375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	16350.2529297		
		Carbon Black (C)	1333-86-4	0.000064	5000	2340.97583008		
		Encapsulation Total:				0.012761	1000000	466768.625
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000112	1000000	4096.70800781		
					TOTAL MASS (g) :	0.027339		